74VCXH16245

Low-Voltage 1.8/2.5/3.3V 16-Bit Transceiver
With 3.6 V–Tolerant Inputs and Outputs (3–State, Non–Inverting)

The 74VCXH16245 is an advanced performance, non–inverting 16–bit transceiver. It is designed for very high–speed, very low–power operation in 1.8 V, 2.5 V or 3.3 V systems.

When operating at 2.5 V (or 1.8 V) the part is designed to tolerate voltages it may encounter on either inputs or outputs when interfacing to 3.3 V busses. It is guaranteed to be over–voltage tolerant to 3.6 V.

The VCXH16245 is designed with byte control. It can be operated as two separate octals, or with the controls tied together, as a 16–bit wide function. The Transmit/Receive (T/$\overline{\text{R}}$n) inputs determine the direction of data flow through the bi–directional transceiver. Transmit (active–HIGH) enables data from A ports to B ports; Receive (active–LOW) enables data from B to A ports. The Output Enable inputs ($\overline{\text{OEn}}$), when HIGH, disable both A and B ports by placing them in a HIGH Z condition. The data inputs include active bushold circuitry, eliminating the need for external pull–up resistors to hold unused or floating inputs at a valid logic state.

- Designed for Low Voltage Operation: V_{CC} = 1.65–3.6 V
- 3.6 V Tolerant Inputs and Outputs
- High Speed Operation: 2.5 ns max for 3.0 to 3.6 V
  3.0 ns max for 2.3 to 2.7 V
  6.0 ns max for 1.65 to 1.95 V
- Static Drive: ±24 mA Drive at 3.0 V
  ±18 mA Drive at 2.3 V
  ±6 mA Drive at 1.65 V
- Supports Live Insertion and Withdrawal
- Includes Active Bushold to Hold Unused or Floating Inputs at a Valid Logic State
- I_{OFF} Specification Guarantees High Impedance When V_{CC} = 0 V[†]
- Near Zero Static Supply Current in All Three Logic States (20 µA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds ±250 mA @ 125°C
- ESD Performance: Human Body Model >2000 V; Machine Model >200 V

†NOTE: To ensure the outputs activate in the 3–state condition, the output enable pins should be connected to V_{CC} through a pull–up resistor. The value of the resistor is determined by the current sinking capability of the output connected to the $\overline{\text{OE}}$ pin.

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MARKING DIAGRAM

TSSOP–48
DT SUFFIX
CASE 1201

48

74VCXH16245DT
AWLYYWW

1
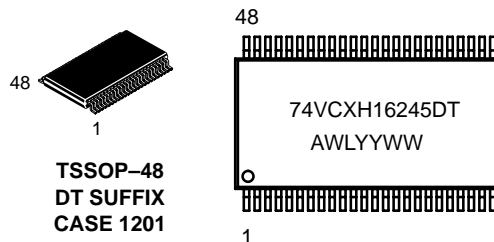
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
74VCXH16245DT	TSSOP	39 / Rail
74VCXH16245DTR	TSSOP	2500 / Reel

74VCXH16245
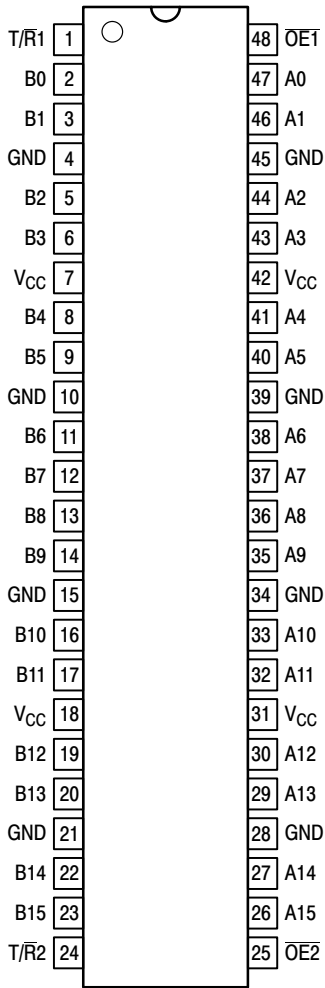
Figure 1. 48–Lead Pinout
(Top View)

T/R̄1 [1]   [48] OĒ1
B0 [2]   [47] A0
B1 [3]   [46] A1
GND [4]   [45] GND
B2 [5]   [44] A2
B3 [6]   [43] A3
V_CC [7]   [42] V_CC
B4 [8]   [41] A4
B5 [9]   [40] A5
GND [10]   [39] GND
B6 [11]   [38] A6
B7 [12]   [37] A7
B8 [13]   [36] A8
B9 [14]   [35] A9
GND [15]   [34] GND
B10 [16]   [33] A10
B11 [17]   [32] A11
V_CC [18]   [31] V_CC
B12 [19]   [30] A12
B13 [20]   [29] A13
GND [21]   [28] GND
B14 [22]   [27] A14
B15 [23]   [26] A15
T/R̄2 [24]   [25] OĒ2

PIN NAMES

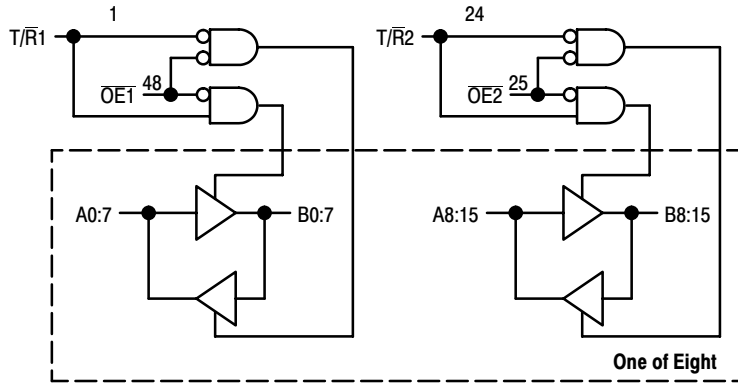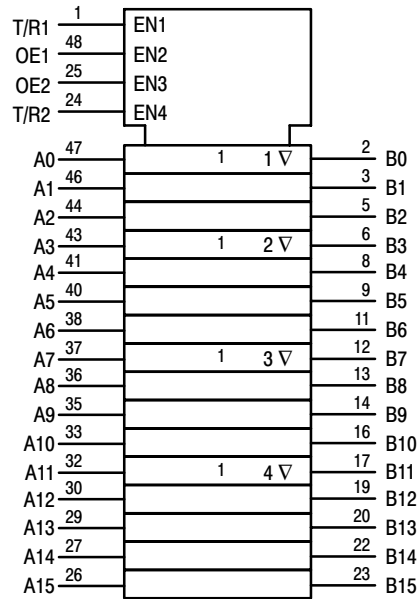| Pins	Function
OĒn	Output Enable Inputs
T/R̄n	Transmit/Receive Inputs
A0–A15	Side A Inputs or 3–State Outputs
B0–B15	Side B Inputs or 3–State Outputs

Figure 2. Logic Diagram

Figure 3. IEC Logic Diagram

Inputs		Outputs	Inputs		Outputs
OĒ1	T/R̄1		OĒ2	T/R̄2	
L	L	Bus B0:7 Data to Bus A0:7	L	L	Bus B8:15 Data to Bus A8:15
L	H	Bus A0:7 Data to Bus B0:7	L	H	Bus A8:15 Data to Bus B8:15
H	X	High Z State on A0:7, B0:7	H	X	High Z State on A8:15, B8:15

H = High Voltage Level; L = Low Voltage Level; X = High or Low Voltage Level and Transitions Are Acceptable

74VCXH16245

ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V_{CC}	DC Supply Voltage	−0.5 to +4.6		V
V_I	DC Input Voltage	$−0.5 \leq V_I \leq +4.6$		V
V_O	DC Output Voltage	$−0.5 \leq V_O \leq +4.6$	Output in 3−State	V
		$−0.5 \leq V_O \leq V_{CC} + 0.5$	Note 1.; Outputs Active	V
I_{IK}	DC Input Diode Current	−50	$V_I <$ GND	mA
I_{OK}	DC Output Diode Current	−50	$V_O <$ GND	mA
		+50	$V_O > V_{CC}$	mA
I_O	DC Output Source/Sink Current	±50		mA
I_{CC}	DC Supply Current Per Supply Pin	±100		mA
I_{GND}	DC Ground Current Per Ground Pin	±100		mA
T_{STG}	Storage Temperature Range	−65 to +150		°C

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute−maximum−rated conditions is not implied.

1. I_O absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Typ	Max	Unit
V_{CC}	Supply Voltage	Operating	1.65	3.3	3.6	V
		Data Retention Only	1.2	3.3	3.6	
V_I	Input Voltage		−0.3		3.6	V
V_O	Output Voltage	(Active State)	0		V_{CC}	V
		(3−State)	0		3.6	
I_{OH}	HIGH Level Output Current, V_{CC} = 3.0V − 3.6V				−24	mA
I_{OL}	LOW Level Output Current, V_{CC} = 3.0V − 3.6V				24	mA
I_{OH}	HIGH Level Output Current, V_{CC} = 2.3V − 2.7V				−18	mA
I_{OL}	LOW Level Output Current, V_{CC} = 2.3V − 2.7V				18	mA
I_{OH}	HIGH Level Output Current, V_{CC} = 1.65 − 1.95V				−6	mA
I_{OL}	LOW Level Output Current, V_{CC} = 1.65 − 1.95V				6	mA
T_A	Operating Free−Air Temperature		−40		+85	°C
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate, V_{IN} from 0.8V to 2.0V, V_{CC} = 3.0V		0		10	ns/V

DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	$T_A = -40°C$ to $+85°C$		Unit
			Min	Max	
V_{IH}	HIGH Level Input Voltage (Note 2.)	$1.65V \leq V_{CC} < 2.3V$	$0.65 \times V_{CC}$		V
		$2.3V \leq V_{CC} \leq 2.7V$	1.6		
		$2.7V < V_{CC} \leq 3.6V$	2.0		
V_{IL}	LOW Level Input Voltage (Note 2.)	$1.65V \leq V_{CC} < 2.3V$		$0.35 \times V_{CC}$	V
		$2.3V \leq V_{CC} \leq 2.7V$		0.7	
		$2.7V < V_{CC} \leq 3.6V$		0.8	
V_{OH}	HIGH Level Output Voltage	$1.65V \leq V_{CC} \leq 3.6V; I_{OH} = -100\mu A$	$V_{CC} - 0.2$		V
		$V_{CC} = 1.65V; I_{OH} = -6mA$	1.25		
		$V_{CC} = 2.3V; I_{OH} = -6mA$	2.0		
		$V_{CC} = 2.3V; I_{OH} = -12mA$	1.8		
		$V_{CC} = 2.3V; I_{OH} = -18mA$	1.7		
		$V_{CC} = 2.7V; I_{OH} = -12mA$	2.2		
		$V_{CC} = 3.0V; I_{OH} = -18mA$	2.4		
		$V_{CC} = 3.0V; I_{OH} = -24mA$	2.2		
V_{OL}	LOW Level Output Voltage	$1.65V \leq V_{CC} \leq 3.6V; I_{OL} = 100\mu A$		0.2	V
		$V_{CC} = 1.65V; I_{OL} = 6mA$		0.3	
		$V_{CC} = 2.3V; I_{OL} = 12mA$		0.4	
		$V_{CC} = 2.3V; I_{OL} = 18mA$		0.6	
		$V_{CC} = 2.7V; I_{OL} = 12mA$		0.4	
		$V_{CC} = 3.0V; I_{OL} = 18mA$		0.4	
		$V_{CC} = 3.0V; I_{OL} = 24mA$		0.55	
I_I	Input Leakage Current	$1.65V \leq V_{CC} \leq 3.6V; 0V \leq V_I \leq 3.6V$		± 5.0	μA
$I_{I(HOLD)}$	Minimum Bushold Input Current	$V_{CC} = 3.0V, V_{IN} = 0.8V$	75		μA
		$V_{CC} = 3.0V, V_{IN} = 2.0V$	-75		
		$V_{CC} = 2.3V, V_{IN} = 0.7V$	45		
		$V_{CC} = 2.3V, V_{IN} = 1.6V$	-45		
		$V_{CC} = 1.65V, V_{IN} = 0.57V$	25		
		$V_{CC} = 1.65V, V_{IN} = 1.07V$	-25		
$I_{I (OD)}$	Minimum Bushold Over–Drive Current Needed to Change State	$V_{CC} = 3.6V$, (Note 3.)	450		μA
		$V_{CC} = 3.6V$, (Note 4.)	-450		
		$V_{CC} = 2.7V$, (Note 3.)	300		
		$V_{CC} = 2.7V$, (Note 4.)	-300		
		$V_{CC} = 1.95V$, (Note 3.)	200		
		$V_{CC} = 1.95V$, (Note 4.)	-200		
I_{OZ}	3–State Output Current	$1.65V \leq V_{CC} \leq 3.6V; 0V \leq V_O \leq 3.6V;$ $V_I = V_{IH}$ or V_{IL}		± 10	μA
I_{OFF}	Power–Off Leakage Current	$V_{CC} = 0V; V_I$ or $V_O = 3.6V$		10	μA
I_{CC}	Quiescent Supply Current (Note 5.)	$1.65V \leq V_{CC} \leq 3.6V; V_I = GND$ or V_{CC}		20	μA
		$1.65V \leq V_{CC} \leq 3.6V; 3.6V \leq V_I, V_O \leq 3.6V$		± 20	μA
ΔI_{CC}	Increase in I_{CC} per Input	$2.7V < V_{CC} \leq 3.6V; V_{IH} = V_{CC} - 0.6V$		750	μA

2. These values of V_I are used to test DC electrical characteristics only.
3. An external driver must source at least the specified current to switch from LOW–to–HIGH.
4. An external driver must source at least the specified current to switch from HIGH–to–LOW.
5. Outputs disabled or 3–state only.

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AC CHARACTERISTICS (Note 6.; $t_R = t_F = 2.0ns$; $C_L = 30pF$; $R_L = 500\Omega$)

Symbol	Parameter	Waveform	Limits						Unit
			$T_A = -40°C$ to $+85°C$						
			V_{CC} = 3.0V to 3.6V		V_{CC} = 2.3V to 2.7V		V_{CC} = 1.65 to1.95V		
			Min	Max	Min	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay Input to Output	1	0.8 0.8	2.5 2.5	1.0 1.0	3.0 3.0	1.5 1.5	6.0 6.0	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	2	0.8 0.8	3.8 3.8	1.0 1.0	4.9 4.9	1.5 1.5	9.3 9.3	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	2	0.8 0.8	3.7 3.7	1.0 1.0	4.2 4.2	1.5 1.5	7.6 7.6	ns
t_{OSHL} t_{OSLH}	Output–to–Output Skew (Note 7.)			0.5 0.5		0.5 0.5		0.75 0.75	ns

6. For $C_L = 50pF$, add approximately 300ps to the AC maximum specification.
7. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH–to–LOW (t_{OSHL}) or LOW–to–HIGH (t_{OSLH}); parameter guaranteed by design.

DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Characteristic	Condition	$T_A = +25°C$	Unit
			Typ	
V_{OLP}	Dynamic LOW Peak Voltage (Note 8.)	V_{CC} = 1.8V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	0.25	V
		V_{CC} = 2.5V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	0.6	
		V_{CC} = 3.3V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	0.8	
V_{OLV}	Dynamic LOW Valley Voltage (Note 8.)	V_{CC} = 1.8V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	−0.25	V
		V_{CC} = 2.5V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	−0.6	
		V_{CC} = 3.3V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	−0.8	
V_{OHV}	Dynamic HIGH Valley Voltage (Note 9.)	V_{CC} = 1.8V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	1.5	V
		V_{CC} = 2.5V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	1.9	
		V_{CC} = 3.3V, C_L = 30pF, $V_{IH} = V_{CC}$, V_{IL} = 0V	2.2	

8. Number of outputs defined as "n". Measured with "n–1" outputs switching from HIGH–to–LOW or LOW–to–HIGH. The remaining output is measured in the LOW state.
9. Number of outputs defined as "n". Measured with "n–1" outputs switching from HIGH–to–LOW or LOW–to–HIGH. The remaining output is measured in the HIGH state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C_{IN}	Input Capacitance	Note 10.	6	pF
C_{OUT}	Output Capacitance	Note 10.	7	pF
C_{PD}	Power Dissipation Capacitance	Note 10., 10MHz	20	pF

10. V_{CC} = 1.8, 2.5 or 3.3V; V_I = 0V or V_{CC}.

WAVEFORM 1 – PROPAGATION DELAYS
$t_R = t_F = 2.0ns$, 10% to 90%; $f = 1MHz$; $t_W = 500ns$

WAVEFORM 2 – OUTPUT ENABLE AND DISABLE TIMES
$t_R = t_F = 2.0ns$, 10% to 90%; $f = 1MHz$; $t_W = 500ns$
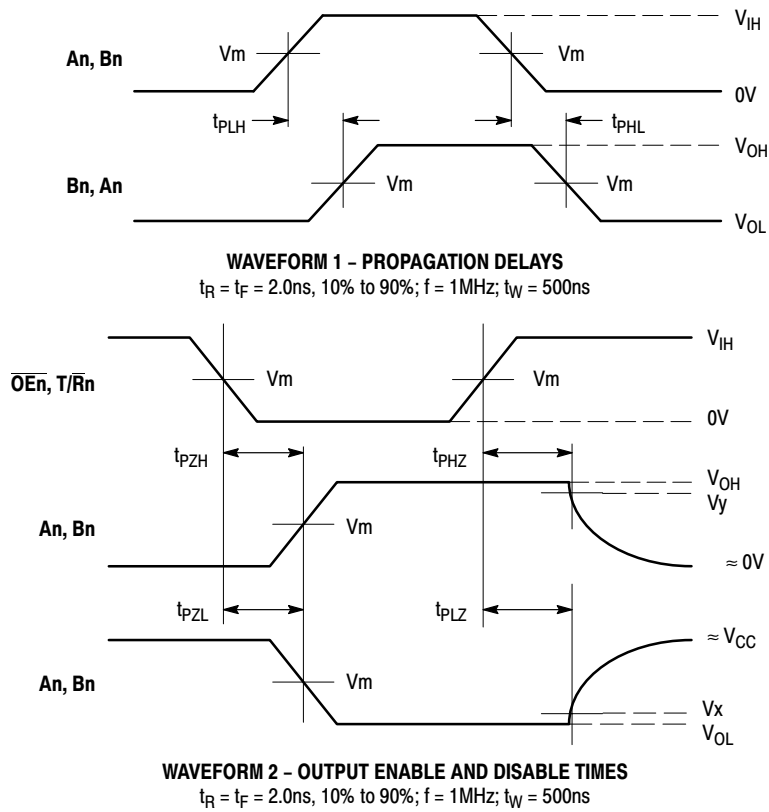
Figure 4. AC Waveforms

	V_{CC}		
Symbol	**3.3V $\pm$0.3V**	**2.5V $\pm$0.2V**	**1.8V $\pm$0.15V**
V_{IH}	2.7V	V_{CC}	V_{CC}
V_m	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_x	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
V_y	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$	$V_{OH} - 0.15V$
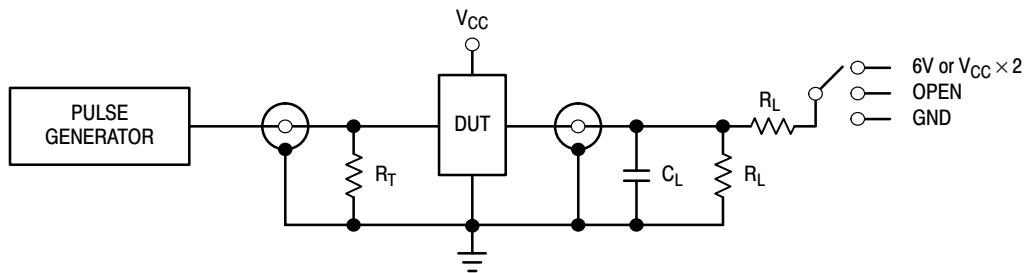
TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	6V at $V_{CC} = 3.3 \pm 0.3V$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2V$; 1.8V $\pm$0.15V
t_{PZH}, t_{PHZ}	GND

C_L = 30pF or equivalent (Includes jig and probe capacitance)
R_L = 500Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50Ω)

Figure 5. Test Circuit

WAVEFORM 3 – PROPAGATION DELAYS
$t_R = t_F = 2.0ns$, 10% to 90%; $f = 1MHz$; $t_W = 500ns$

WAVEFORM 4 – OUTPUT ENABLE AND DISABLE TIMES
$t_R = t_F = 2.0ns$, 10% to 90%; $f = 1MHz$; $t_W = 500ns$

Figure 6. AC Waveforms

Symbol	V_{CC}	
	3.3V ±0.3V	2.7V
V_{IH}	2.7V	2.7V
V_m	1.5V	1.5V
V_x	$V_{OL} + 0.3V$	$V_{OL} + 0.3V$
V_y	$V_{OH} - 0.3V$	$V_{OH} - 0.3V$
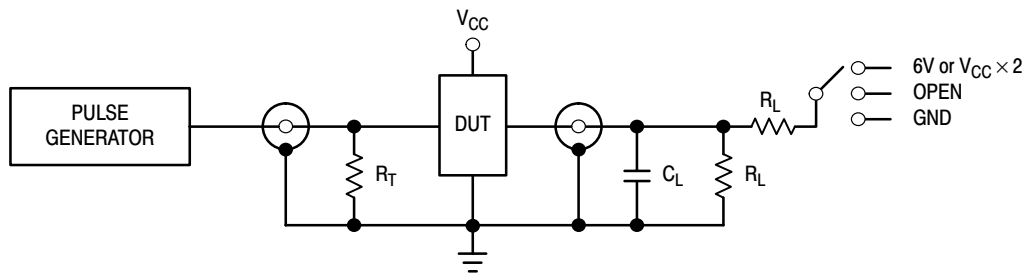
TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	6V at $V_{CC} = 3.3 ±0.3V$; $V_{CC} \times 2$ at $V_{CC} = 2.5 ±0.2V$; 1.8 ±0.15V
t_{PZH}, t_{PHZ}	GND

C_L = 50pF or equivalent (Includes jig and probe capacitance)
R_L = 500Ω or equivalent
$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 7. Test Circuit

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AC CHARACTERISTICS ($t_R = t_F = 2.0ns$; $C_L = 50pF$; $R_L = 500\Omega$)

Symbol	Parameter	Waveform	$T_A = -40°C$ to $+85°C$				Unit
			V_{CC} = 3.0V to 3.6V		V_{CC} = 2.7V		
			Min	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay Input to Output	3	1.0 1.0	3.0 3.0		3.6 3.6	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	4	1.0 1.0	4.4 4.4		5.4 5.4	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	4	1.0 1.0	4.1 4.1		4.6 4.6	ns
t_{OSHL} t_{OSLH}	Output–to–Output Skew (Note 11.)			0.5 0.5		0.5 0.5	ns

11. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH–to–LOW (t_{OSHL}) or LOW–to–HIGH (t_{OSLH}); parameter guaranteed by design.

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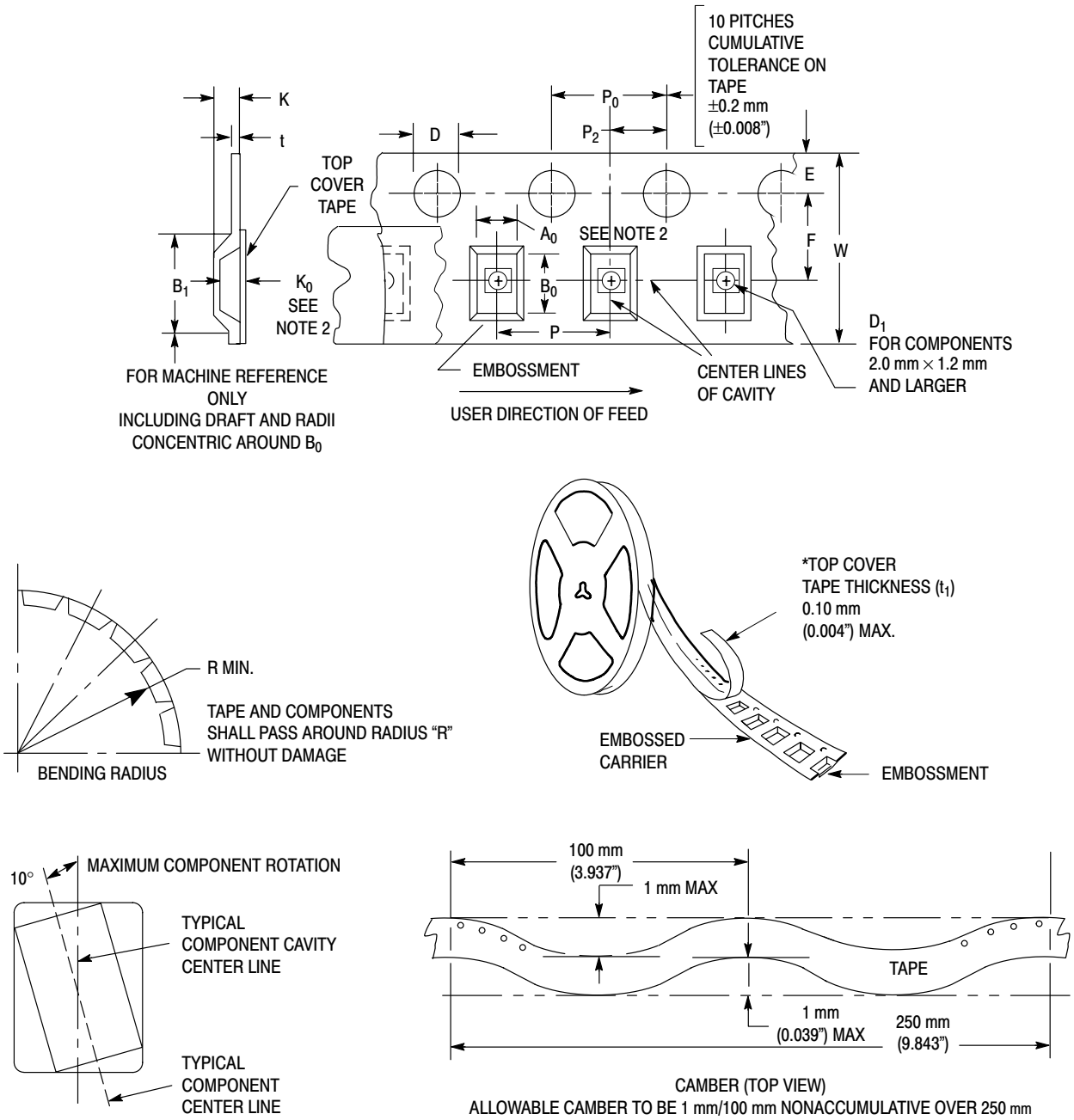
Figure 8. Carrier Tape Specifications

EMBOSSED CARRIER DIMENSIONS (See Notes 1 and 2)

Tape Size	B_1 Max	D	D_1	E	F	K	P	P_0	P_2	R	T	W
24mm	20.1mm (0.791")	1.5 + 0.1mm −0.0 (0.059 +0.004" −0.0)	1.5mm Min (0.060")	1.75 ±0.1 mm (0.069 ±0.004")	11.5 ±0.10 mm (0.453 ±0.004")	11.9 mm Max (0.468")	16.0 ±0.1 mm (0.63 ±0.004")	4.0 ±0.1 mm (0.157 ±0.004")	2.0 ±0.1 mm (0.079 ±0.004")	30 mm (1.18")	0.6 mm (0.024")	24.3 mm (0.957")

1. Metric Dimensions Govern–English are in parentheses for reference only.
2. A_0, B_0, and K_0 are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity.

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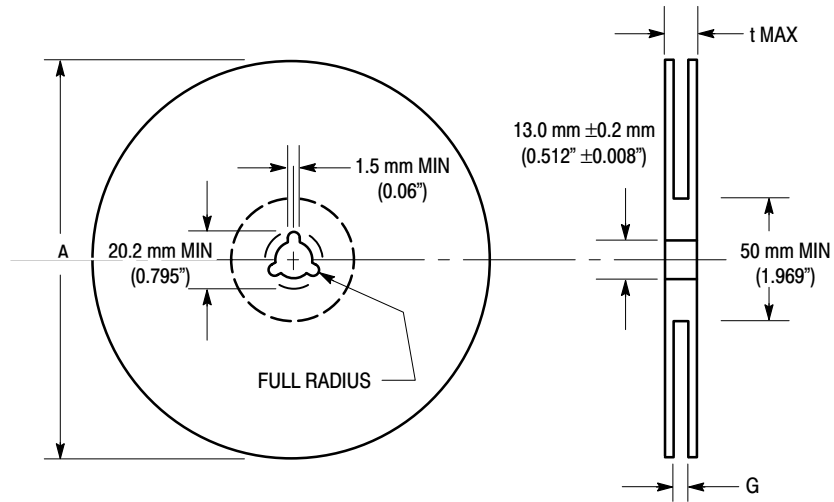
Figure 9. Reel Dimensions

REEL DIMENSIONS

Tape Size	A Max	G	t Max
24 mm	360 mm (14.173")	24.4 mm + 2.0 mm, −0.0 (0.961" + 0.078", −0.00)	30.4 mm (1.197")
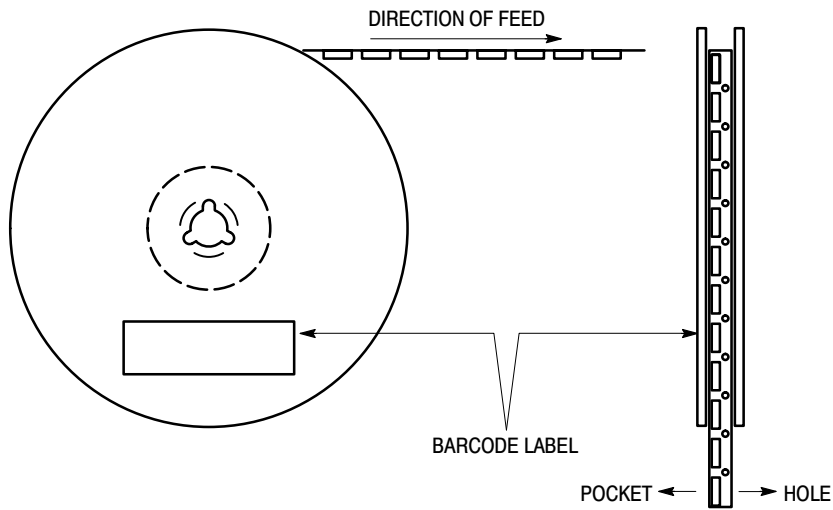
Figure 10. Reel Winding Direction

74VCXH16245
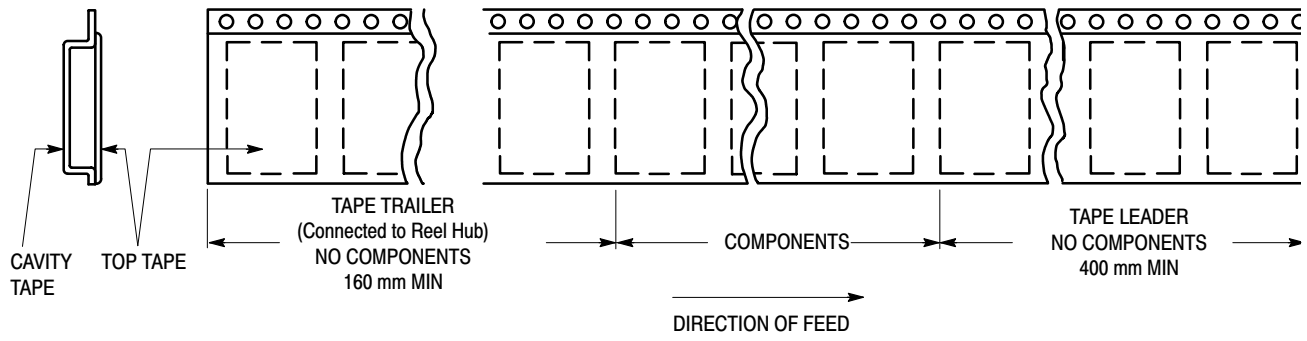
Figure 11. Tape Ends for Finished Goods

User Direction of Feed
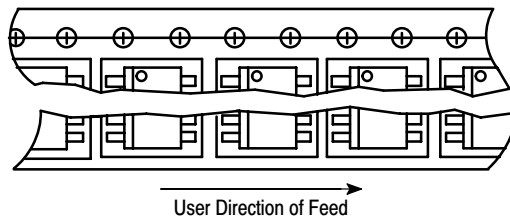
Figure 12. Reel Configuration

48 Leads
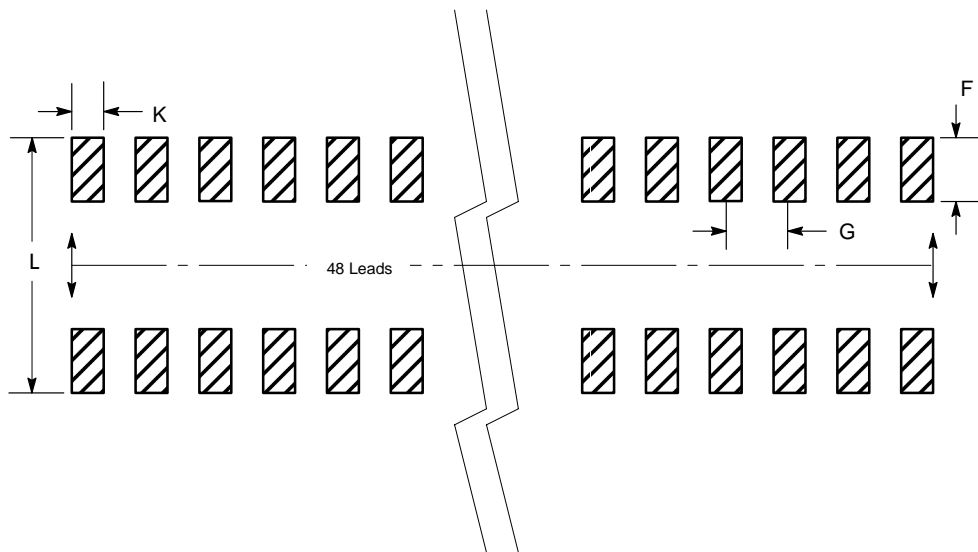
Figure 13. Package Footprint

74VCXH16245

PACKAGE DIMENSIONS

TSSOP
DT SUFFIX
CASE 1201–01
ISSUE A
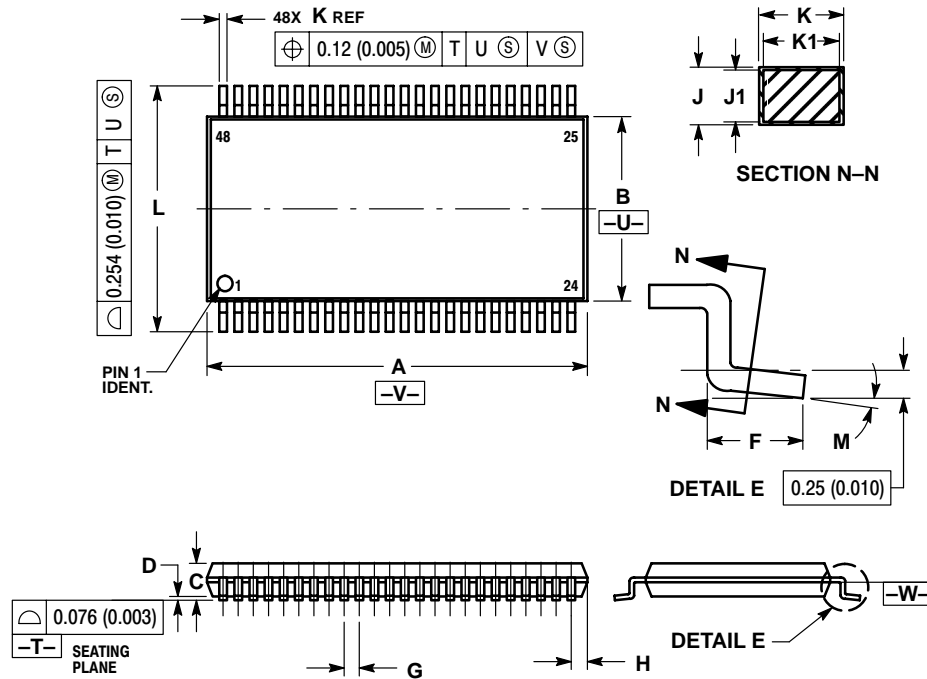
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE –W–.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	12.40	12.60	0.488	0.496
B	6.00	6.20	0.236	0.244
C	---	1.10	---	0.043
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.50 BSC		0.0197 BSC	
H	0.37	---	0.015	---
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.17	0.27	0.007	0.011
K1	0.17	0.23	0.007	0.009
L	7.95	8.25	0.313	0.325
M	0 °	8 °	0 °	8 °

PUBLICATION ORDERING INFORMATION

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